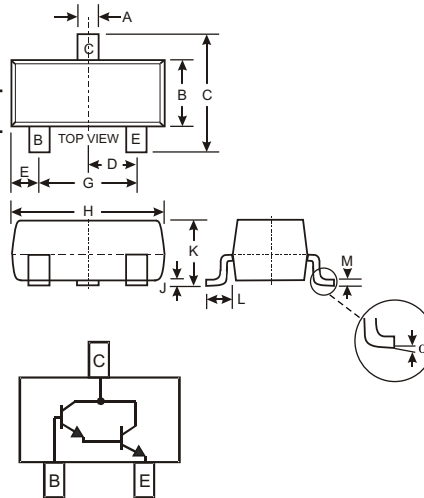


Features

- Epitaxial Planar Die Construction
- Ideal for Low Power Amplification and Switching
- High Current Gain
- Lead Free/RoHS Compliant (Note 1)

Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Terminal Connections: See Diagram
- Marking (See Page 3): K1D
- Ordering & Date Code Information: See Page 3
- Weight: 0.008 grams (approximate)



| SOT-23 | | |
|----------------------|-------|-------|
| Dim | Min | Max |
| A | 0.37 | 0.51 |
| B | 1.20 | 1.40 |
| C | 2.30 | 2.50 |
| D | 0.89 | 1.03 |
| E | 0.45 | 0.60 |
| G | 1.78 | 2.05 |
| H | 2.80 | 3.00 |
| J | 0.013 | 0.10 |
| K | 0.903 | 1.10 |
| L | 0.45 | 0.61 |
| M | 0.085 | 0.180 |
| | 0 | 8 |
| All Dimensions in mm | | |

Maximum Ratings @ T_A = 25 C unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|--------------------------------|------------------|-------|------|
| Collector-Base Voltage | V _{CB0} | 40 | V |
| Collector-Emitter Voltage | V _{CEO} | 40 | V |
| Emitter-Base Voltage | V _{EBO} | 12 | V |
| Collector Current - Continuous | I _C | 500 | mA |

Thermal Characteristics

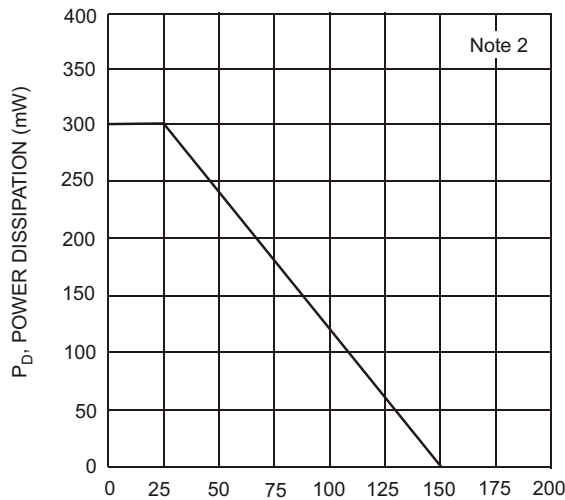
| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 2) @ T _A = 25 C | P _d | 300 | mW |
| Thermal Resistance, Junction to Ambient (Note 2) @ T _A = 25 C | R _{JA} | 417 | C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | C |

- Note:
1. No purposefully added lead.
 2. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

Electrical Characteristics @ $T_A = 25\text{ C}$ unless otherwise specified

| Characteristic | Symbol | Min | Max | Unit | Test Condition |
|--------------------------------------|---------------|----------------------------|-------------------------------|------|---|
| OFF CHARACTERISTICS (Note 3) | | | | | |
| Collector-Base Breakdown Voltage | $V_{(BR)CBO}$ | 40 | | V | $I_C = 100\text{ A}, I_E = 0$ |
| Collector-Emitter Breakdown Voltage | $V_{(BR)CEO}$ | 40 | | V | $I_C = 10\text{mA}, I_B = 0$ |
| Emitter-Base Breakdown Voltage | $V_{(BR)EBO}$ | 12 | | V | $I_E = 10\text{ A}, I_C = 0$ |
| Collector Cutoff Current | I_{CBO} | | 50 | nA | $V_{CB} = 30\text{V}, I_E = 0$ |
| Collector Cutoff Current | I_{CEO} | | 1.0 | A | $V_{CE} = 25\text{V}, I_B = 0$ |
| Emitter Cutoff Current | I_{EBO} | | 50 | nA | $V_{EB} = 10\text{V}, I_C = 0$ |
| ON CHARACTERISTICS (Note 3) | | | | | |
| DC Current Gain | h_{FE} | 10,000 20,000 14,000 | 100,000 200,000 140,000 | | $I_C = 10\text{mA}, V_{CE} = 5.0\text{V}$ $I_C = 100\text{mA}, V_{CE} = 5.0\text{V}$ $I_C = 500\text{mA}, V_{CE} = 5.0\text{V}$ |
| Collector-Emitter Saturation Voltage | $V_{CE(SAT)}$ | | 1.2 1.5 | V | $I_C = 50\text{mA}, I_B = 0.5\text{mA}$ $I_C = 500\text{mA}, I_B = 0.5\text{mA}$ |
| Base-Emitter Saturation Voltage | $V_{BE(SAT)}$ | | 2.0 | V | $I_C = 500\text{mA}, I_B = 0.5\text{mA}$ |
| Base-Emitter On Voltage | $V_{BE(ON)}$ | | 1.75 | V | $I_C = 50\text{mA}, V_{CE} = 5.0\text{V}$ |
| SMALL SIGNAL CHARACTERISTICS | | | | | |
| Output Capacitance | C_{obo} | 8.0 Typical | | pF | $V_{CB} = 10\text{V}, f = 1.0\text{MHz}, I_E = 0$ |
| Input Capacitance | C_{ibo} | 15 Typical | | pF | $V_{EB} = 0.5\text{V}, f = 1.0\text{MHz}, I_C = 0$ |

Note: 3. Short duration pulse test used to minimize self-heating effect.



T_A , AMBIENT TEMPERATURE ($^{\circ}\text{C}$)
Fig. 1, Max Power Dissipation vs Ambient Temperature

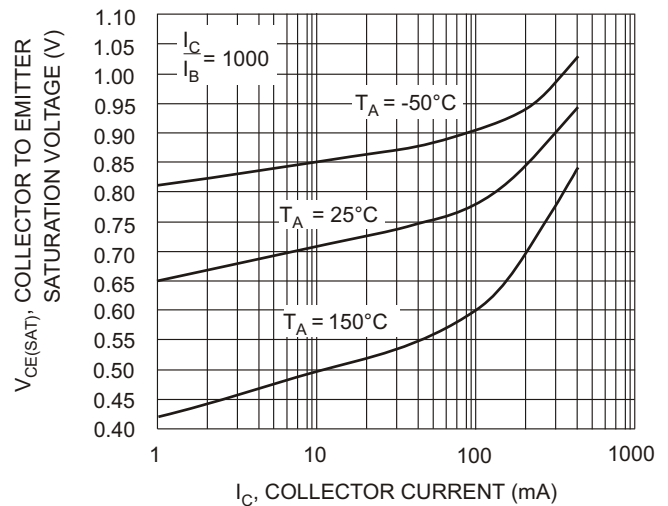


Fig. 2, Collector Emitter Saturation Voltage vs. Collector Current

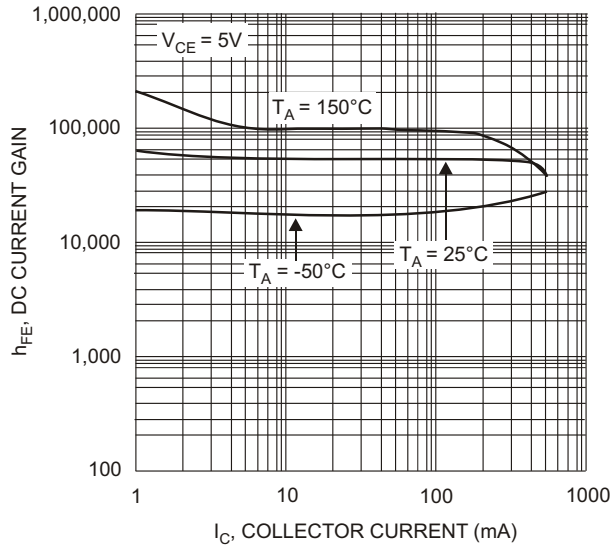


Fig. 3, DC Current Gain vs Collector Current

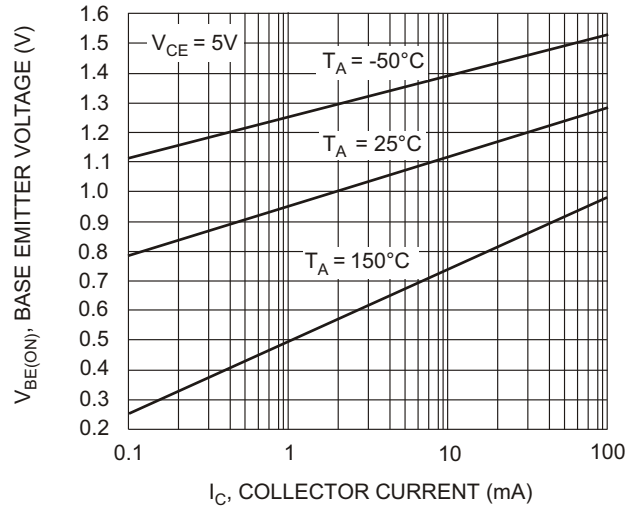


Fig. 4, Base Emitter Voltage vs. Collector Current

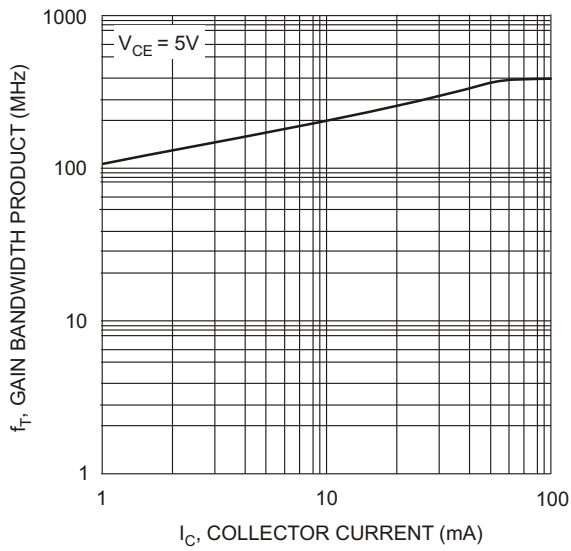


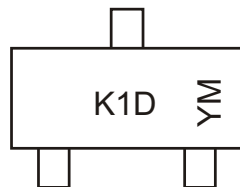
Fig. 5, Gain Bandwidth Product vs Collector Current

Ordering Information (Note 4)

| Device | Packaging | Shipping |
|--------------|-----------|------------------|
| MMBT6427-7-F | SOT-23 | 3000/Tape & Reel |

Notes: 4. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



K1D = Product Type Marking Code
 YM = Date Code Marking
 Y = Year ex: N = 2002
 M = Month ex: 9 = September

Date Code Key

| Year | 1998 | 1999 | 2000 | 2001 | 2002 | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 |
|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code | J | K | L | M | N | P | R | S | T | U | V | W | X | Y | Z |

| Month | Jan | Feb | March | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

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